

广东星坤科技股份有限公司

日期

文件工程章

MARK	DESCRIPTION	DATE	REVISED	APPROVED	UNSPECIFIED TOLERANCES
Δ*					ANGLAR ±5°
Δx					L ≤ 4 ±0.2
Δx					4 < L ≤ 16 ±0.3
					16 < L ≤ 63 ±0.4
					L > 63 ±0.5
					REVISIONS
					www.helloxkb.com www.helloxkb.cn www.xk-dg.cn



DSND		SCALE: N/A	MODEL TYPE:
DWN		VIEW:	PART NO.: X1304WWS-52X-LPV10
CHKD		UNIT: mm/in	DWG NO.: X-X1304WWS-52X-LPV10
APPD		SIZE: A4	WEIGHT SHEET REVISION
			1/1 A0

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NOTES 注释:

1. MATERIAL材料:

HOUSING外壳: THERMOPLASTIC, HIGH TEMP.,
UL94V-0;BLACK COLOR

CONTACTS触点: COPPER ALLOY.

PEGS螺钉: COPPER ALLOY.

2. FINISH饰面:

CONTACT触点:SELECTEIVE GOLD PLATING ON CONTACT AREA.
100μ"MIN. MATTE TIN PLATING ON SOLDER TAILS,
50μ" MIN. NICKEL UNDERPLATING OVERALL.

PEGS螺钉: 120u" MIN. MATTE-TIN OVER 50u" MIN. NICKEL.

X1304 W V S - 52 X - LP V10

① ② ③④ ⑤ ⑥ ⑦ ⑧

① Series Number

② Terminal form: W-Wafer

③ Welding Board Angle : V-Stright Angle 180°

④ Welding Way:S-SMT

⑤ No.of Pins: 52 PIN

⑥ HEIGHT: A 4.0mm;B 5.2mm;C 5.6mm;D 6.8mm;
E 7.0mm;F 8.0mm;G 9.0mm;H 9.9mm

⑦ Plastic material: LP-LCP UL94V-0

⑧ Contact Plating:V01-Gold Flash
V10-Gold 10 u"
V30-Gold 30 u"

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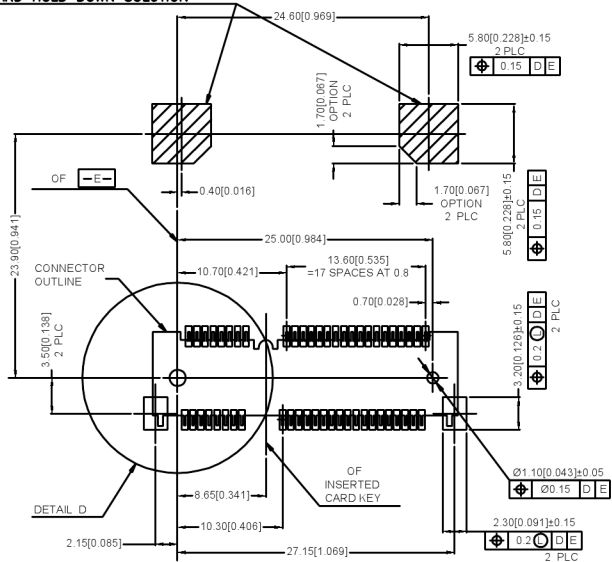
Δ	日期
Δ	
Δ	
MARK	文件工程章

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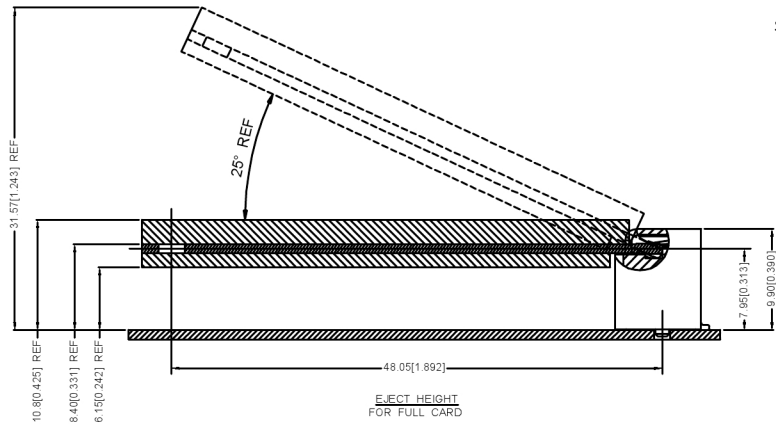
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XKB INDUSTRIAL PRECISION CO.,LIMITED		SHEET 1/1
		REVISION A0



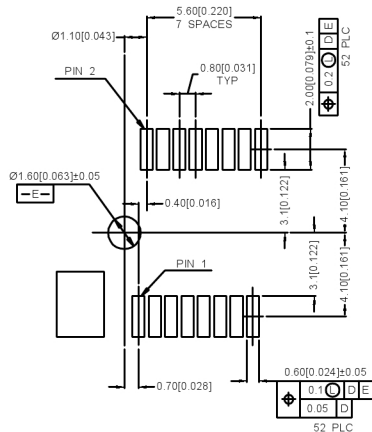
COMPONENT KEEP OUT AREA FOR
CARD HOLD DOWN SOLUTION



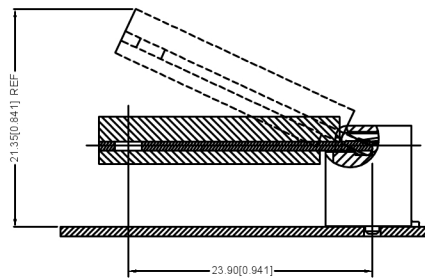
—D— IS THE TOP SURFACE OF PCB.
RECOMMENDED P.C. BOARD PATTERN LAYOUT
FOR HALF CARD CONNECTOR
(TOP VIEW)



EJECT HEIGHT
FOR FULL CARD

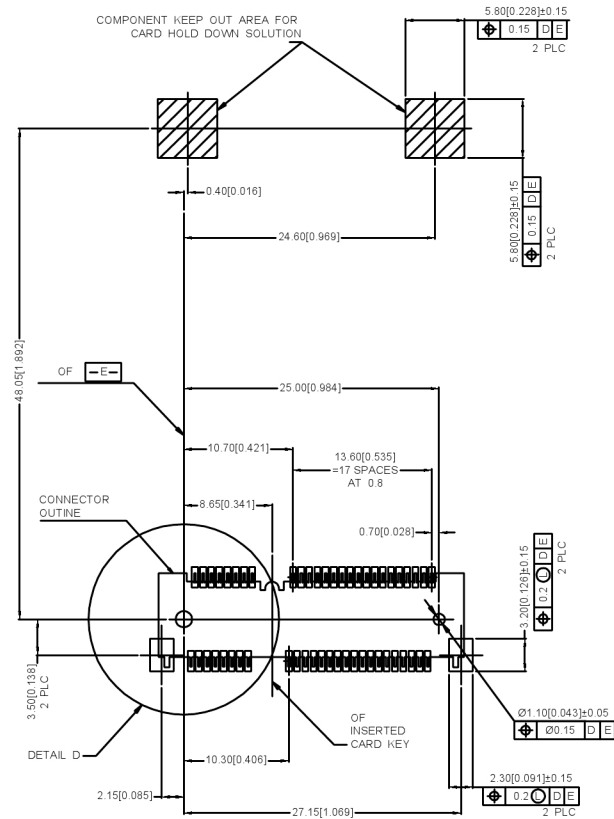


DETAIL D
SCALE 2:1



EJECT HEIGHT
FOR HALF CARD

COMPONENT KEEP OUT AREA FOR
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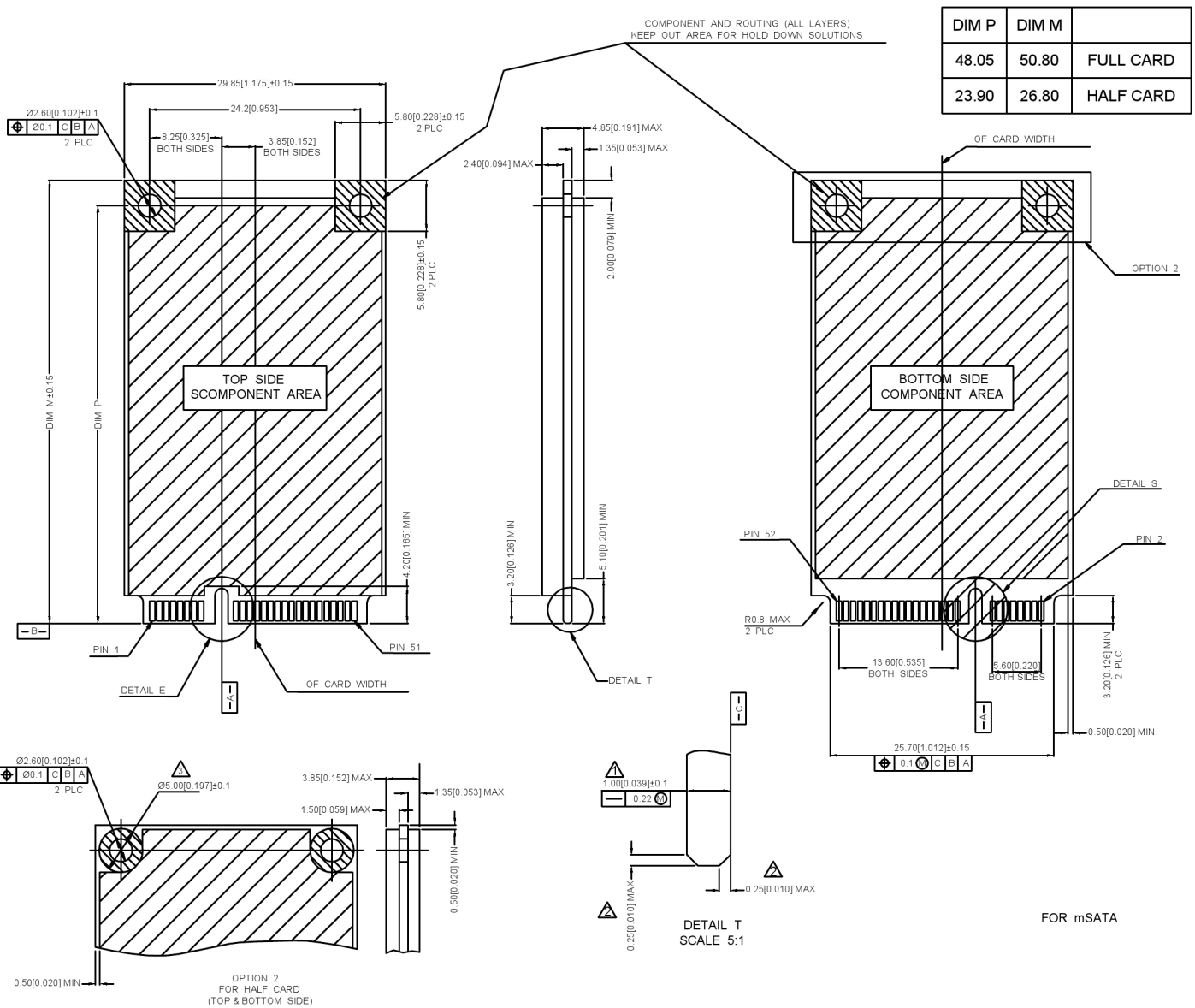
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Δ改	日期
ΔX	
MARK	DESCRIPTION

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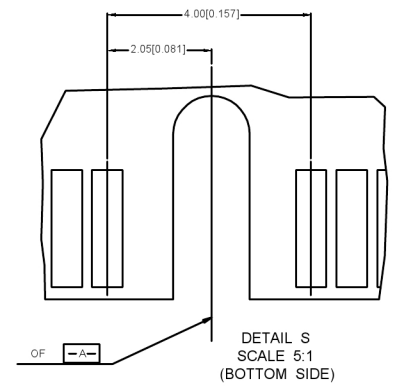
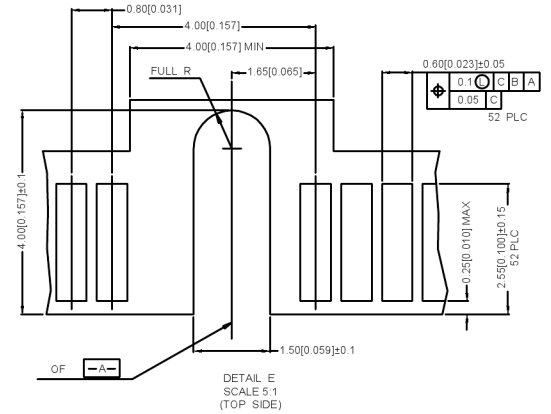
XKLB

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APPD		SIZE: A4	X-X1304WVS-52X-LPV10
		WEIGHT	SHEET
			REVISION

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DIM P	DIM M	
48.05	50.80	FULL CARD
23.90	26.80	HALF CARD



- NOTES 注释:
- △ CARD THICKNESS APPLIES ACROSS TABS AND INCLUDES PLATING AND/OR METALLIZATION.
卡片厚度适用于所有接线片，包括电镀和/或金属化。
 - △ EDGE BEVEL MUST BE IPRESENT AND FREE OF CUTTING CONTACT MATERIALS BURRS FROM AND PCB
边缘斜面必须均匀且无切割接触材料毛刺和PCB
 - △ COMPONENT AND ROUTING (TOP/BOTTOM LAYER) KEEP OUT AREA FOR HOLD DOWN SOLUTIONS.
元件和布线(顶层/底层)为压紧解决方案留出区域

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姓名	日期
数量	日期
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